Mini SMD LED



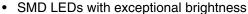
DESCRIPTION

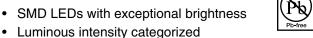
The new MiniLED series have been designed in a small white SMT package. The feature of the device is the very small package 2.3 mm x 1.3 mm x 1.4 mm. The MiniLED is an obvious solution for small-scale, high-power products that are expected to work reliable in an arduous environment. This is often the case in automotive and industrial application.

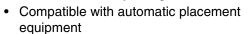
PRODUCT GROUP AND PACKAGE DATA

· Product group: LED Package: SMD MiniLED · Product series: standard Angle of half intensity: ± 60°

FEATURES









- · IR reflow soldering
- Available in 8 mm tape
- · Low profile package
- · Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packing unit $I_{Vmax.}/I_{Vmin.} \le 2.0$, optional ≤ 1.6
- · Lead (Pb)-free device
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC
- Automotive qualified AEC-Q101

APPLICATIONS

- · Automotive: backlighting in dashboards and switches
- · Telecommunication: indicator and backlighting in telephone and fax
- · Indicator and backlight for audio and video equipment
- · Indicator and backlight in office equipment
- Flat backlight for LCDs, switches and symbols

PARTS TABLE		
PART	COLOR, LUMINOUS INTENSITY	TECHNOLOGY
VLMP23K2M2-GS08	Pure green, $I_V = (9 \text{ to } 28) \text{ mcd}$	AllnGaP on GaAs

ABSOLUTE MAXIMUM	RATINGS ¹⁾ VLMP23			
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage ²⁾		V _R	5	V
DC Forward current	T _{amb} ≤ 80 °C	I _F	30	mA
Surge forward current	t _p ≤ 10 μs	I _{FSM}	0.1	Α
Power dissipation		P _V	80	mW
Junction temperature		Tj	125	°C
Operating temperature range		T _{amb}	- 40 to + 100	°C
Storage temperature range		T _{stg}	- 40 to + 100	°C
Thermal resistance junction/ ambient	mounted on PC board (pad size > 5 mm ²)	R _{thJA}	580	K/W

¹⁾ T_{amb} = 25 °C, unless otherwise specified

²⁾ Driving the LED in reverse direction is suitable for a short term application



OSRAM

LPM676-K2M1

OPTICAL AND ELE	OPTICAL AND ELECTRICAL CHARACTERISTICS ¹⁾ VLMP23, PURE GREEN						
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity ²⁾	I _F = 20 mA	VLMP23K2M2	Ι _V	9		28	mcd
Dominant wavelength	I _F = 20 mA		λ_{d}	555	560	565	nm
Peak wavelength	I _F = 20 mA		λ_{p}		555		nm
Angle of half intensity	I _F = 20 mA		φ		± 60		deg
Forward voltage	I _F = 20 mA		V _F		2.2	2.6	V
Reverse voltage	I _R = 10 μA		V_{R}	5			V
Junction capacitance	V _R = 0, f = 1 MHz		C _j		15		pF

Note:

²⁾ In one packing unit $I_{Vmax}/I_{Vmin.} \le 2.0$

LUMINOUS	INTENSIT	Y CLASSIF	CATION
GROUP	LIGH	IT INTENSITY (I	ncd)
STANDARD	OPTIONAL	MIN.	MAX.
К	1	7.1	9
N.	2	9	11.2
	1	11.2	14
L	2	14	18
M	1	18	22.4
IVI	2	22.4	28

Note:

Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of \pm 11 %.

The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel).

In order to ensure availability, single brightness groups will not be orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel.

In order to ensure availability, single wavelength groups will not be orderable.

COLOR CLASSIFIC	ATION	
	DOMINANT WA	AVELENGTH (nm)
GROUP	PURE	GREEN
	MIN	MAX
0	555	559
1	558	561
2	560	563
3	562	565

Note:

CROSSING TABLE
VISHAY

VLMP23K2M2

Wavelengths are tested at a current pulse duration of 25 ms and an accuracy of \pm 1 nm.

TYPICAL CHARACTERISTICS

T_{amb} = 25 °C, unless otherwise specified

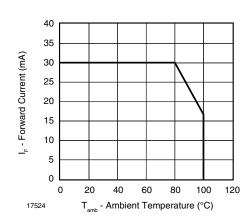


Figure 1. Forward Current vs. Ambient Temperature

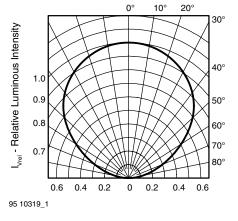
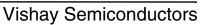


Figure 2. Rel. Luminous Intensity vs. Angular Displacement

 $T_{amb} = 25 \, ^{\circ}C$, unless otherwise specified





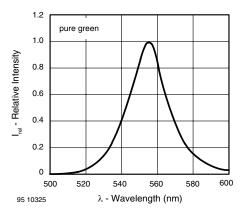


Figure 3. Relative Intensity vs. Wavelength

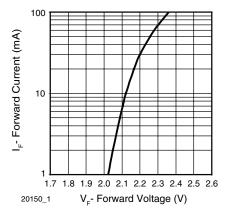


Figure 4. Forward Current vs. Forward Voltage

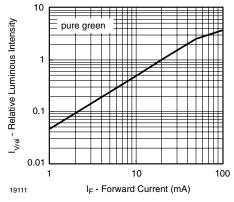


Figure 5. Relative Luminous Intensity vs.
Forward Current

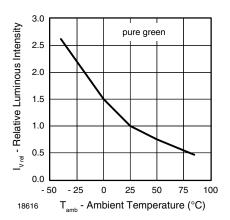


Figure 6. Rel. Luminous Intensity vs. Ambient Temperature

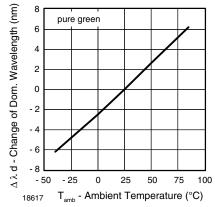


Figure 7. Change of Dominant Wavelength vs.

Ambient Temperature

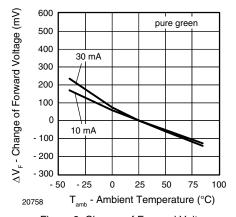
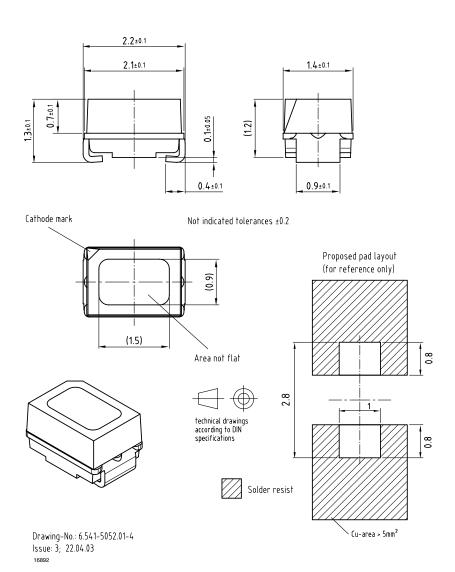


Figure 8. Change of Forward Voltage vs.
Ambient Temperature



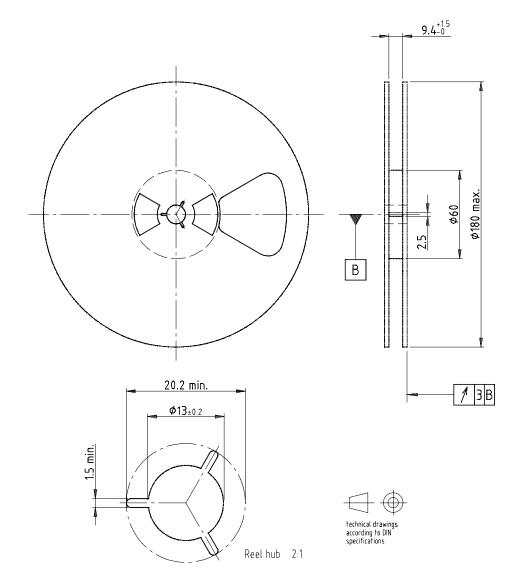
PACKAGE DIMENSIONS in millimeters







REEL DIMENSIONS in millimeters



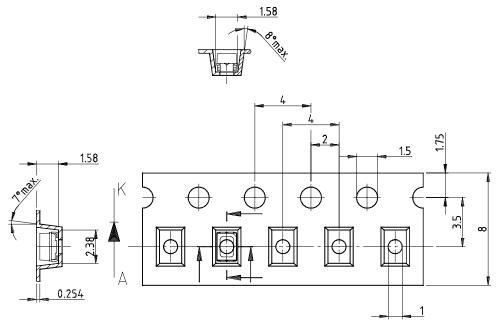
Drawing-No.: 9.800-5051.V5-4

Issue: 1; 25.07.02

16938

VISHAY.

TAPE DIMENSIONS in millimeters

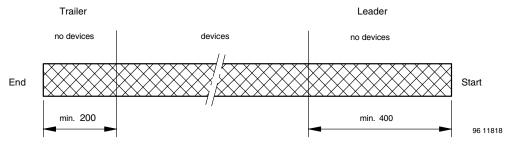


Drawing-No.: 9.700-5266.01-4

Issue: 1; 05.06.02

16939

LEADER AND TRAILER Dimensions in millimeters



GS08 = 3000 pcs

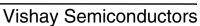
COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 to 1.3 N 300 ± 10 mm/min 165° - 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.





PLAIN WRITTING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by:	ACC	-
Packed by:	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx ⁺	Company Logo
LONG BAR CODE TOP	TYPE	LENGTH
tem-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	<u>_</u>	17

SOLDERING PROFILE

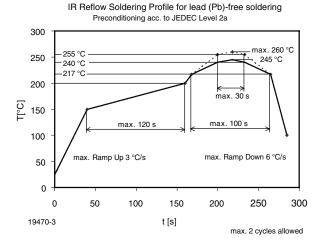
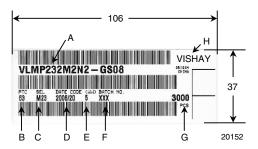


Figure 9. Vishay Lead (Pb)-free Reflow Soldering Profile (acc. to J-STD-020C)

BAR CODE PRODUCT LABEL EXAMPLE:



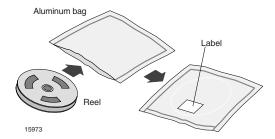
- A) Type of component
- B) Manufacturing plant
- C) SEL selection code (bin):

e.g.: M2 = code for luminous intensity group 3 = code for color group

- D) Date code year/week
- E) Day code (e.g. 5: Friday)
- F) Batch no.
- G) Total quantity
- H) Company code

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.





The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

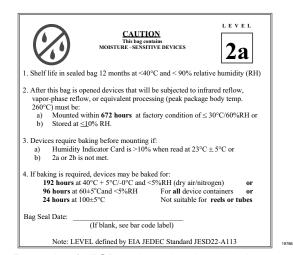
192 h at 40 °C + 5 °C/- 0 °C and < 5 % RH (dry air/nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 2a label is included on all dry bags.





Example of JESD22-A112 level 2a label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.





OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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Vishay

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